

Power Metal Strip Resistors Surface Mount

Features

- Molded high temperature encapsulation.
- Improved thermal management incorporated into design.

• All welded construction of the Power Metal Strip resistors are ideal for all types of current sensing, voltage division and pulse applications.

- Sulfur resistance by construction that is unaffected by high sulfur environments.
- Solid metal nickel-chrome or manganese- copper alloy resistive element with low TCR (< 20 ppm/°C)
- Very low inductance 0.5 nH to 10 nH.
- Low thermal EMF (< 5 μV/°C)

Part number

<u>PMS</u>	<u>MS 45</u>		<u>5P0</u>	<u>R120</u>
【1】	【2】	[3]	【4】	[5]

- [1] Series Name: Power Metal Strip Resistors.
- (2) Chip Size: 45: 4527.
- [3] Resistance Precision: F: ±1%.
- [4] Power Rating: 5P0: 5W.
- [5] Resistance Code: R080:80m Ω , R120:120m Ω , 8M20:8.2m Ω .

Electrical Characteristics

Size	Power Rating at 70℃(W)	Resistance Range (mΩ) [*] ±1%	Element TCR (ppm/℃)	Operation Temperature Range	Product temperature coefficient (ppm/℃)	Insulation resistance
4527	5	5~120	<20	-55℃~+170 ℃	±75: 10mΩ≤R≤120mΩ ±110: 5mΩ≤R<10mΩ	>109

"*" : Other values may be available, contact factory

Note:

- 1) Ir = $(P/R)^{1/2}$ R: Resistance Value Ir: Rating Current P: Rating Power;
- 2) Product temperature coefficient: Includes the TCR effects of the resistor element and the copper terminal.



Physical Dimensions



Unit: mm

Туре	Resistance (mΩ)	L	н	т	W	W1
PMS45	5~120	11.60±0.60	2.50±0.30	2.80±0.50	7.00±0.3	5.46±0.20

Recommended Solder Pad Layout



Marking Instructions

PMS45 is marked with four digit, We have two different ways of marking:

- a. "R" designates the decimal location in ohms,
 - e. g. $80m\Omega$: R080; 120m Ω : R120
- b. "m" designates the decimal location in milliohms,
 - e. g. 8.2mΩ: 8m20



Power Derating Curve

For resistors operated in ambient temperatures 70°C, power rating shall be derated in according with the curve below:



Ambient Temperature °C

Recommended Solder Curve



Reflow Condition		Pb – Free assembly	
	 Temperature Min (T_s(min)) 	150°C	
Pre heat	- Temperature Max (T _s (max))	200°C	
	- Time (Min to Max) (t _s)	60 – 120 secs	
Average ramp	up rate (Liquidus Temp (T _L) to peak	5°C/second max	
T _s (max)	to T _L - Ramp-up Rate	5°C/second max	
Poflow	- Temperature (T∟) (Liquidus)	217°C	
	- Time (t∟)	60 – 150 seconds	
Peal	k Temperature (T _P)	260°C	
Time wit	thin 5°C of actual peak emperature (t _p)	20 – 40 seconds	
R	amp-down Rate	5°C/second max	
Time 25°C	to peak Temperature (T _P)	8 minutes Max.	
v	Vave Soldering	260°C, 10 seconds max.	
H	land Soldering	350°C, 5 seconds max.	



Product Characteristics

Item	Test condition/ Methods	Limited	Standard	
Resistance	Measuring resistance value at room temperature 25°C±5°C	Refer to Spec	IEC60115-1 4.5	
Temperature coefficient of resistance	TCR =(R-R ₀)/R ₀ (T ₂ -T ₁)X 10 ⁶ R ₀ : resistance of room temperature R: resistance of 125 °C T ₁ : Room temperature T ₂ : Temperature at 125 °C	Refer to Spec	MIL-STD-202 Method 304	
Short time Overload	3 times the rated power for 5 seconds	≤±2%	MIL-R-26E	
Resistance to Soldering Heat	260℃±5℃ time: 12sec±0.5sec	≤±0.5%	MIL-STD-202 Method 210	
Solderability	235℃±5℃ time: 2sec±0.5sec	95% coverage minimum	J-STD-202	
Temperature Cycling	-55℃ (15min)/+150℃(15min), 1000 cycles	≤±0.5%	MIL-STD-202 Method107G	
Low temperature Storage	-55 $^\circ \!\!\!\! \mathbb{C}$ for 24 hours, No power	≤±0.5%	MIL-STD-26E	
High Temperature Storage	170 $^\circ \!$	≤±1%	IEC60115-1 4.25	
Bias Humidity	+85℃,85% RH,10%bias, 1000hours	≤±0.5%	MIL-STD-202 Method103	
Mechanical shock	Condition C ,100 g's ,6 msec, 3 mutually perpendicular axes, in 6 directions, three impacts each for a total of 18 times 18 shocks.	≤±0.5%	MIL-STD-202 Method 213	
Vibration	The frequency varies from 10HZ to 55HZ and return to 10HZ, shall be transferred in 1 min. Amplitude : 1.5mm, 3 directions, and 12 hours	≤±0.5%	MIL-STD-202 Method 201	
Bending	Span between fulcrums: 90mm ; Bend Width: 2mm; Test board: Glass-Epoxy Board Thickness =1.6mm Durations:60+5s	≤±1%	IEC60115-1 4.33	
Operational life	70°C ± 2°C, 1000 hours, at rated power	≤±2%	MIL-STD-202 Method 108	
Moisture resistance	MIL-STD-202,method106, No power, 7b not required	≤±0.5%	MIL-STD-202 Method 106	



Packaging

Tape Dimensions



Unit: mm

Series	Туре	А	В	D0	Е	F	φD1
4527	5-120mΩ	7.28±0.10	11.86±0.10	1.50±0.10	1.75±0.10	11.50±0.10	1.50±0.10
Series	Туре	W	P0	P1	P2	т	
4527	5-120mΩ	24.0±0.30	4.00±0.10	12.0±0.10	2.00±0.10	2.71±0.10	

Reel Dimensions



Unit: mm

Series	Туре	W (mm)	M (mm)	ФА (mm)	N (mm)	H1 (mm)	H2 (mm)
4527	13' reel	24.4±1.0	330.0±2.0	13.4±0.5	100.0±0.2	24.4±1.0	28.6±1.0

Quantity of Package

Туре	Quantity (pcs)
4527	1500



Storage

1. The temperature condition must be controlled at 25 ± 5 °C , The R.H. must be controlled at

 $60\pm15\%$ Store in accordance with this requirement, and the validity period is two years after the date of manufacture.

- Please avoid the mentioned harsh environment below when storing to ensure product performance and its' weldability. Places exposed to sea breeze or other corrosive gas, such as Cl₂, H₂S, NH₃, SO₂ and NO₂.
- When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.